1 Application Notes for Differential Hall IC's

Applications

- Detection of rotational speed of ferromagnetic gear wheels
- Detection of rotational position
- Detection of rotational speed of magnetic encoder wheels
- Generation of trigger signals

Main Features

- Evaluation of very small magnetic field differences
- Large airgap in dynamic mode
- Low cut-off frequency
- Fully temperature compensated
- Clean, fast, bounce-free switching
- Direct connection to microcontroller possible
- No mechanical wear and tear
- Overvoltage and reverse polarity protection
- Guarded against RF interference
- Wide temperature range
- Open-collector output (TLE 4921-3U)
- Current interface (TLE 4923)

General Description

The TLE 4921-3U and the TLE 4923 have a combination of two Hall cells, a differential amplifier and evaluating circuitry, all on a single chip. Evaluating field difference instead of absolute field strength means that disruptive effects, like temperature drifts, manufacturing tolerances and magnetic environment are minimized. Further reduction in interference is obtained by the dynamic evaluation of the difference signal using a highpass filter with an external capacitor.

These IC's are designed for use under aggressive conditions found in automotive applications. A small permanent biasing magnet is required for sensing ferromagnetic gear wheels of various shapes. Correct switching for even the smallest field differences between tooth and gap is guaranteed. The typical lower switching frequency is about 10 Hz for a 470 nF filter capacitor. The TLE 4921-3U is offered in an ultraflat package with four leads (P-SSO-4-1) and the TLE 4923 in the same package with three leads (P-SSO-3-6).

Design and Function of the Chip

When the Hall IC is exposed to a constant magnetic field of either polarity, the two Hall elements will produce the same output signal. The difference is zero, regardless of the absolute field strength. However, if there is a field gradient from one Hall element to the other, because one element faces a field concentrating tooth and the other one a gap of the toothed wheel, then a difference signal is generated. This signal is amplified on the chip. In reality the difference exhibits a small offset which is corrected by the integrated control mechanism. The dynamic differential principle allows a high sensitivity in combination with large airgaps between the sensor surface and the gear wheel.

A Schmitt Trigger is used to digitize the conditioned signal. In the case of the TLE 4921-3U an open-collector output with current sinking capability provides the output signal. The TLE 4923 incorporates a current interface that enables transmission of the output signal through the supply current. Protection against overvoltage and reverse polarity (TLE 4923: Only reverse polarity) as well as against EMI are integrated on both sensors and allow application in the hostile environments found in the automotive industry.

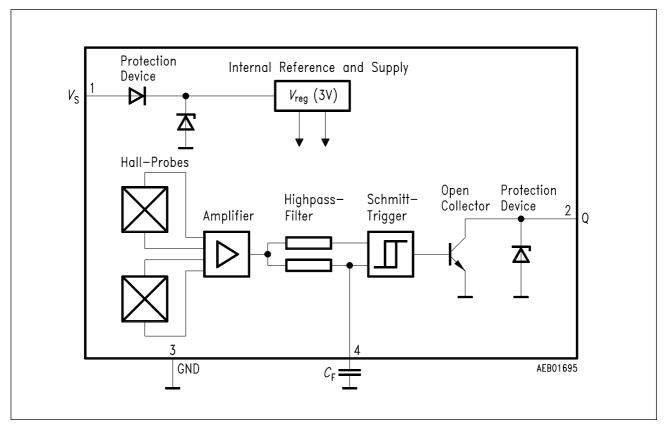


Figure 1
Block Diagram TLE 4921-3U

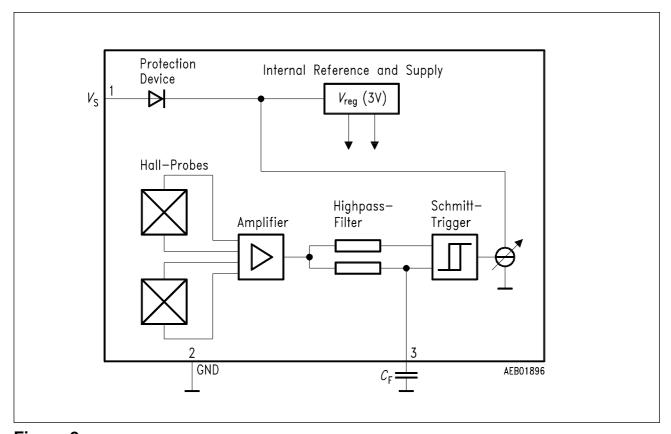


Figure 2 Block Diagram TLE 4923

Method of Operation

The generation and evaluation of the difference signal can be explained with reference to a typical application such as sensing a ferromagnetic gear wheel.

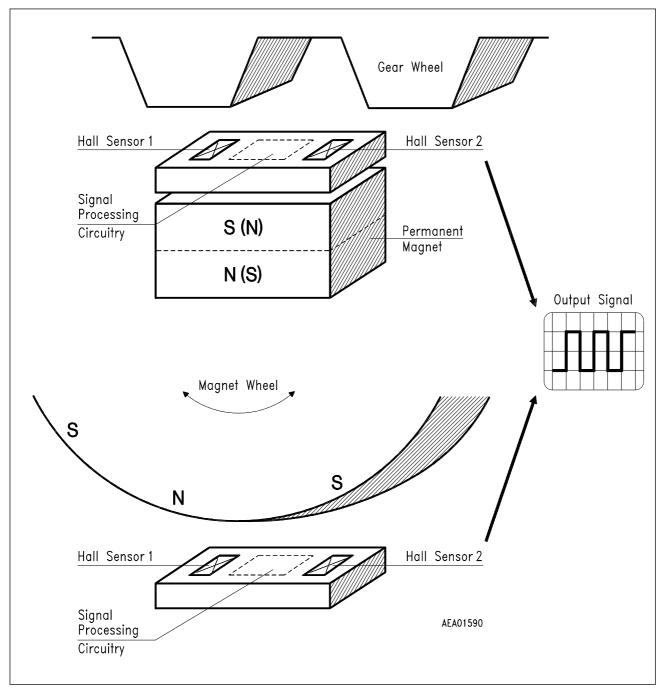


Figure 3
Application as a Gear Wheel Sensor and as an Encoder Wheel Sensor

A permanent magnet mounted with either pole on the rear side of the IC produces a constant magnetic bias field. The two Hall elements are spaced at 2.5 mm. If one cell faces momentarily a tooth while the other faces a gap of the toothed wheel, the gear

tooth acts as a flux concentrator. It increases the flux density through the Hall element and a differential signal is produced. As the toothed gear wheel turns, the differential signal changes its polarity at the same rate of change as from the tooth to the gap.

The maximum difference is produced by the tooth edge when the zero crossover comes directly in the center of the tooth or gap. When the difference exceeds the upper threshold $\Delta B_{\rm RP}$, the output transistor of the TLE 4921-3 will turn OFF ($V_{\rm Q}$ = HIGH). This is the case when the tooth is sensed by the Hall element 2 near pin 4 in **figure 3**. As the difference falls below the lower threshold $\Delta B_{\rm OP}$, the transistor turns ON ($V_{\rm Q}$ = LOW). This is the case when the Hall element 1 near pin 1 senses the tooth.

For the TLE 4923 the situation is similar; for the output ON, the supply current is high and for the output OFF the supply current is low.

The integrated highpass filter regulates the difference signal to zero by means of a time constant that can be set with an external capacitor. In this way only those differences are evaluated that change at a minimum rate (depending on the capacitor value). The output signal is not defined in the steady state. The accuracy that is produced will permit a small switching hysteresis and therefore also a large airgap (up to 3.5 mm).

SIEMENS Si-Hall ICs

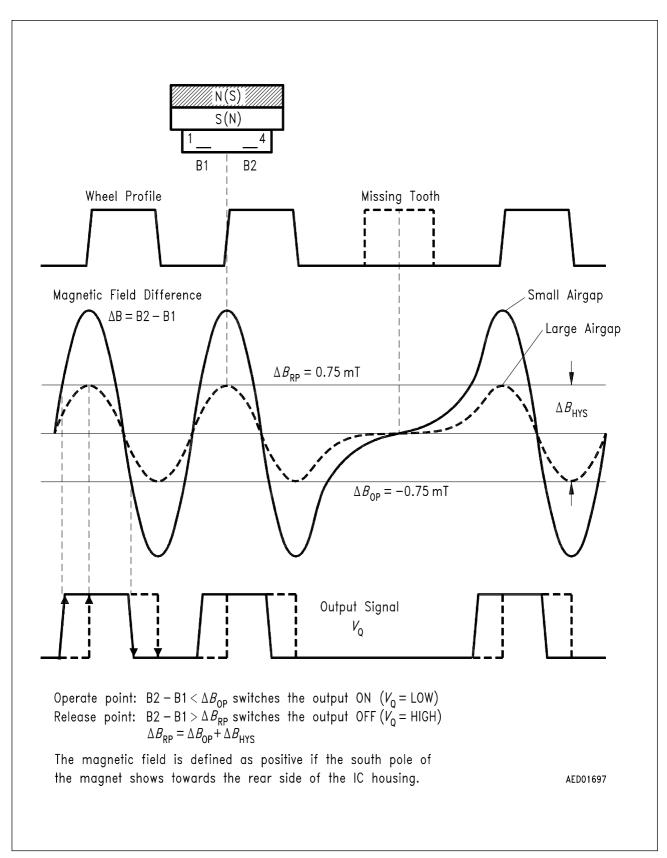


Figure 4
Sensor Signals Produced by a Toothed Gear Wheel, Example TLE 4921-3U

Gear Wheel, Sensing Distance and Angular Accuracy

A gear wheel is characterized by its modulus:

The space T from tooth to tooth, the pitch, is calculated by the formula $T = \pi \cdot m$

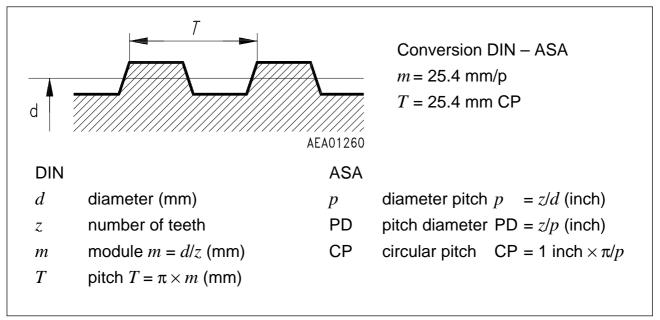


Figure 5
Toothed Wheel Dimensions

The difference in induction is at its greatest when one Hall element faces a tooth and the other one a gap. The spacing between the Hall elements on the IC is 2.5 mm, so the IC can detect a difference from the modulus 1 upwards, the corresponding pitch being 3.14 mm. If the modulus is much greater than 3, or the wheels are irregular, there is a risk of insufficient difference in induction over a longer period, meaning that the output signal will be nondefined.

The maximum possible distance between the sensor and the gear wheel – as a function of temperature, the modulus, the magnet and the speed – will be characterized by the fact that just one impulse manages to appear at the output for each tooth/gap transition.

The following measurements are made with different magnet types:

Table 1

Magnetic type	SmCo ₅	Sm ₂ Co ₁₇	NdFeB	NdFeB
Size (in mm)	$5 \times 4 \times 2.5$	$6 \times 3 \times 5$	ø 5 × 3	ø 7.9 × 2
B at d = 0.5 mm (in mT)	250	300	280	230

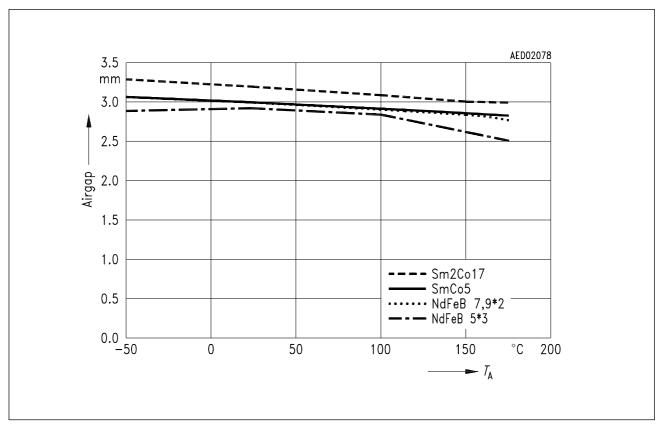


Figure 6
Maximum sensing distance for a gear wheel with modulus 1,5 as a function of biasing magnet

If the distance is reduced, a larger useful signal is produced. Therefore the switching accuracy increases with which a Low/High transition of the sensor can represent an angle of rotation of the gear wheel.

Electromagnetic Compatibility (EMC)

Electromagnetic compatibility is the ability of an electric device to work satisfactorily in an electromagnetic environment without any impermissible influence on this environment (e.g. DIN VDE 0870).

The DIN 40839 and the comparable ISO7637 standards insure EMC in road vehicles and define several types of tests:

DIN 40839-1: Injection of supply line transients (test pulses) in 12 V onboard systems

DIN 40939-2: Injection of supply line transients (test pulses) in 24 V onboard systems

DIN 40839-3: Injection of capacitive line transients

DIN 40839-4: Radiated Interference

The following sections present the test results of the DIN 40839-1, -2 and -4 tests performed with the TLE 4921-3U and show how this Hall IC is to be used in an equipment guaranteeing Electromagnetic Compatibility.

Injection of supply line transients (DIN 40839-1 and -2)

Table 2 shows the amplitudes of the transients. They can be found, together with the other parameters, in the standards. The battery voltage used is $V_{\rm batt}$ = 13.5 V (27 V) for 12 V (24 V) supply voltage. Since part of the pulses are generated with a so called Schaffner Generator, it is sometimes referred to Schaffner test pulses with reference to this test.

Table 2
Severity Level of Test Pulses for 12 V Supply Voltage (24 V Supply Voltage)

Test Pulse	Pulse Amplitude $V_{\mathtt{S}}$ in Volts for Severity Levels			
$\overline{V_{S}}$	1	II	III	IV
1	- 25 (- 50)	- 50 (- 100)	- 75 (- 150)	- 100 (- 200)
2	+ 25 (+ 25)	+ 50 (+ 50)	+ 75 (+ 75)	+ 100 (+ 100)
3a	- 25 (- 35)	- 50 (- 70)	- 100 (- 140)	- 150 (- 200)
3b	+ 25 (+ 35)	+ 50 (+ 70)	+ 75 (+ 140)	+ 100 (+ 200)
4	- 4 (- 5)	- 5 (- 10)	- 6 (- 14)	- 7 (- 16)
5	+ 26.5 (+70)	+ 46.5 (+113)	+ 66.5 (+ 156)	+ 86.5 (+ 200)
6 (only ISO 7637-1)	- 50	– 100	- 200	- 300
7 (only ISO 7637-1)	- 20	- 40	- 60	- 80

For the measurements, the test circuit as in **figure 7** is used. The filter capacitor of 470 nF is connected directly to pin 4, additionally a 4.7 nF shunt capacitor is connected in the supply line. A serial resistance of 300 Ω is used.

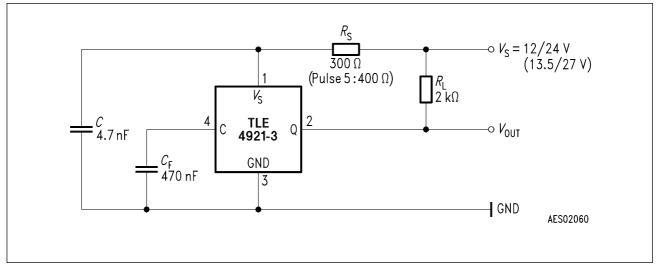


Figure 7
Circuitry for DIN 40839-1/-2 Test

The following failure mode severity classification is used to characterize a device when applying to DIN 40839 and ISO 7637:

- Class A All Functions of a device/system perform as designed during and after exposure to disturbance
- Class B All functions of a device/system perform as designed during exposure: however, one or more of them can go beyond specified tolerance. All functions return automatically to within normal limits after exposure is removed. Memory functions shall remain Class A
- Class C A function of a device/system does not perform as designed during exposure but returns automatically to normal operation after exposure is removed.
- Class D A function of a device/system does not perform as designed during exposure and does not return to normal operation until exposure is removed and the device /system is reset by simple "operator/use" action.
- Class E One or more functions of a device/system does not perform as designed during and after exposure and cannot be returned to proper operation without repairing or replacing the device/system.

According to this classification, the results obtained with the TLE 4921-3 are summarized in **table 2**. The values in parenthesis apply for 24 V battery voltage operation. Detailed results of the measurements are available on request.

Table 3
Functional Status of TLE 4921-3U according to DIN 40839-1/-2 Test Levels

Test Pulse	Functional Status according to Test Levels				
	I	II	III	IV	
1	C (C)	C (C)	C (C)	C (C)	
2	A (A)	B (B)	B (B)	B (B)	A/B: if $t_2 = 60 \mu s$
3a	C (C)	C (C)	C (C)	C (C)	
3b	A (A)	A (C)	C (C)	C (C)	
4	C (C)	C (C)	C (C)	C (C)	
5	B (C)	C (C)	C (C)	C (C/D)	D: if $t_0 > 200 \text{ ms}$
6	С	С	С	С	
7	С	С	С	С	

Radiated Interference (DIN 40839-4)

Measurements of Hall IC's in a TEM cell (Transverse ElectroMagentic) allow precise judgement of the immunity to electromagnetic radiation (EMI) of the device under realistic conditions of use.

For this radiation test, the Hall IC is placed in a homogeneous electromagnetic field, generated between the inner conductor of the TEM cell (septum) and its outer conductor (enclosure). **Figure 8** illustrates the structure of the TEM cell used and the complete setup, including signal generator and readout electronics.

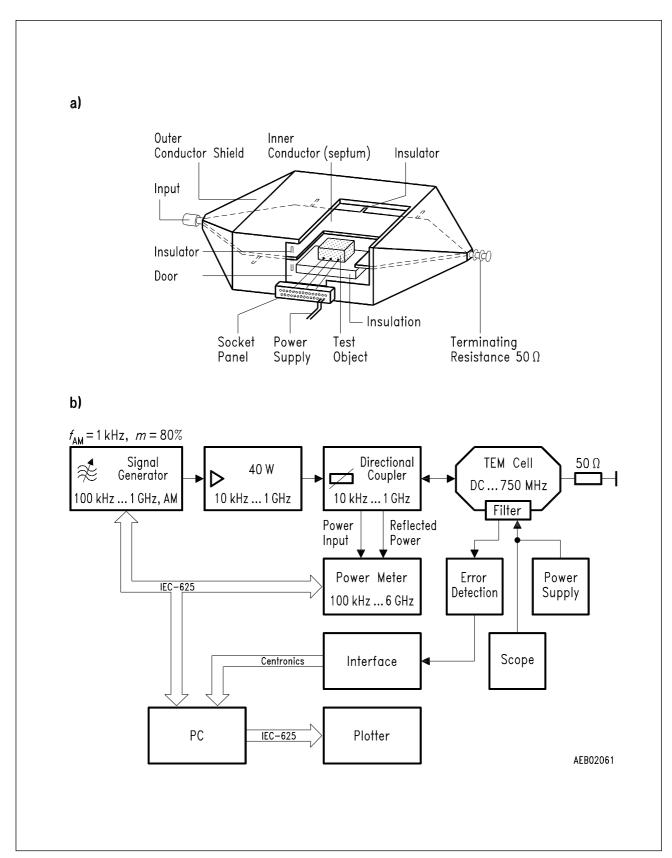


Figure 8
Structure of a TEM Cell for Radiated Interference Test Procedure (DIN 40839-4)

Following the detailed measurement conditions are summarized:

Provided E-field

- Typical maximum 160 V/m, f = 10 kHz to 750 MHz
- AM=1 kHz, m = 80% (peak value of E-field approximately 300 V/m)

Sensor Stimulation

- Target wheel, B = 100 mT \pm 50 mT @f = 100 Hz
- The position of the cables is fixed on a wooden board (thickness 20 mm). The cables must not touch the TEM cell.

Position in the Cell

 As shown in figure 9. Additionally the correct position is ensured with reference sensors. The device is placed in the center of the cell.

Malfunction Detection

- Oscilloscope and frequency counter

Measurement Method

- Frequency sweeps in steps of 1 MHz at the highest E-field level, remaining 1 second at each frequency
- In case of output disturbances: Decrease of E-field to locate the local minimum values

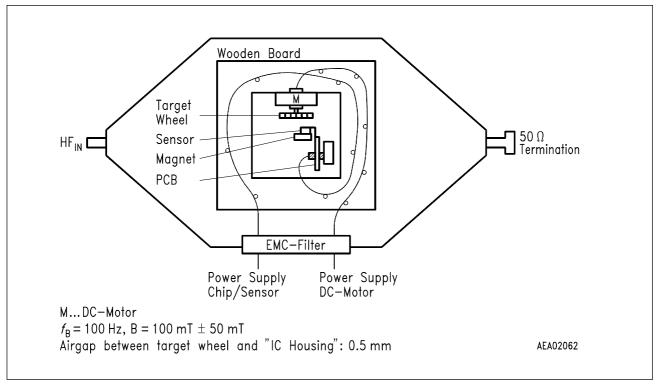


Figure 9
Top View of the TEM Cell with Target Wheel Powered by DC Motor for Sensor Operation

The PC-board, onto which the sensor is mounted, is optimized according the circuit in the following subsection. The results of the TEM measurements with an optimized PCB board are shown in **figure 10**. It is seen that over the whole frequency range the TLE 4921-3 performs without disturbance up to the maximum field of 160V/m. More details on the TEM measurements are available on request.

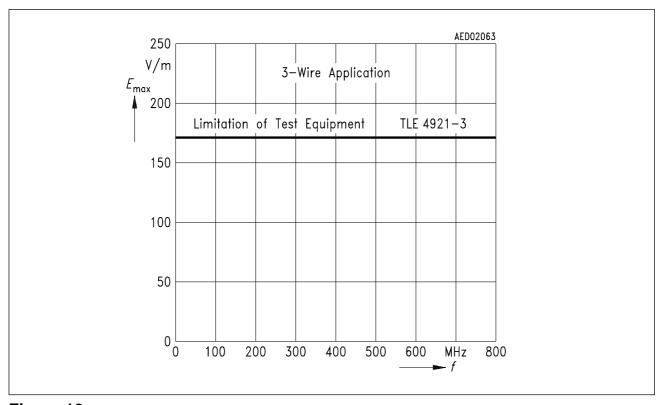


Figure 10
Results of the Radiated Interference Test with the TLE 4921-3U

Optimization of TLE 4921-3U PCB Layout for Improved EMI Performance, Three-wire Configuration

Due consideration of the PC-board layout is a prerequisite for optimized EMI performance of the TLE 4921-3. The following recommendation is the result of EMI measurements carried out on the device during in-house testing.

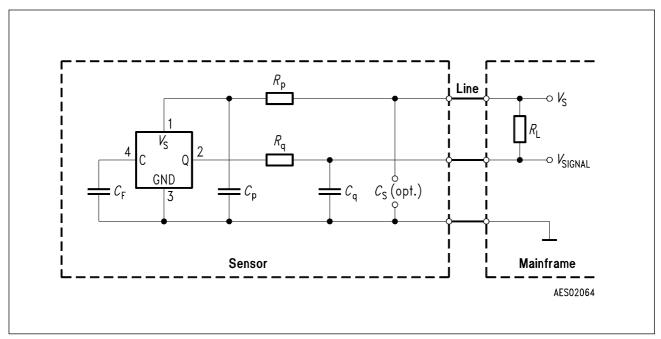


Figure 11
Optimized TLE 4921-3U PCB Circuit for Three-wire Operation

Component values:

$C_{\rm F}$ = 470 nF	High pass filter capacitor
$C_{\rm S}$ = 4.7 nF	Additional HF shunt (optional)
$R_{\rm p}$ = 0-330 Ω	Forms with $C_{\scriptscriptstyle p}$ a low pass filter in the supply line
$C_{\rm p}$ = 4.7 nF	(against conductive coupling and fast interference pulses)
$R_{\rm q}$ = 33 Ω $C_{\rm q}$ = 4.7 nF	Serves with $C_{\rm q}$ to smoothen the falling edge of $V_{\rm SIGNAL}$, i.e. reduction of irradiated interference
$R_1 = 330 \Omega$	Load resistor

Optimization points in detail:

1. Ground

The reference point on the board is the GND pin of the device. In order to avoid conductive interferences, all connections to this pin should be realized in a star configuration. If this requirement is not fulfilled, the EM immunity will be reduced.

2. Connection of the filter capacitor

The connections between the filter capacitor $C_{\rm F}$, the C and GND pins have to be as short as possible (ideally $C_{\rm F}$ should be placed close to the device housing), taking into account the above mentioned star configuration of $C_{\rm F}$ to GND. If this is not possible, a second smaller capacitor (e.g. 82 nF) between $C_{\rm F}$ and TLE 4921-3U is recommended in order to shorten the connection between $C_{\rm F}$ and the corresponding pins. This measure should be applied only if little space is available close to the Hall IC.

3. Groundscreen

In addition it is recommended to lay the GND connection of the filter capacitor out as a groundscreen for the connection of the capacitor to the C pin.

4. Additional HF shunts

Ideally arranged HF shunts $C_{\rm S}$ can further improve the EMI immunity.

The effect of the above listed optimization steps (with decreasing significance) can vary according to the system (sensor, cable, control unit). Depending on the application, not all the measures need to be applied.



Optimization of TLE 4921-3U PCB Layout for Improved EMI Performance, Two-wire Configuration

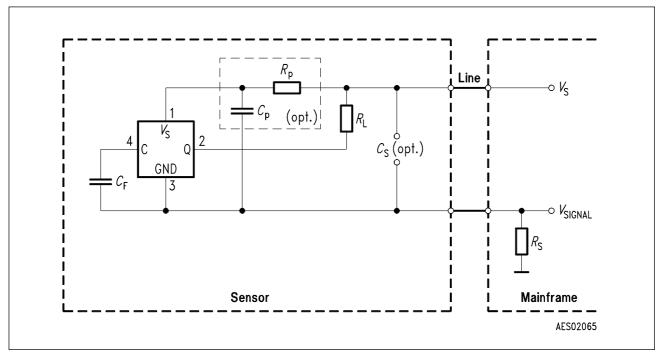


Figure 12
Optimized TLE 4921-3U PCB Circuit for Two-wire Operation

Component values:

$C_{\rm F} = 470 {\rm nF}$	High pass filter capacitor
$C_{\rm S}$ = 4.7 nF	Additional HF shunt (optional)
$R_{\rm S}$ = 120 Ω	Measurement resistor
$R_{\rm L}$ = 330 Ω	Load resistor
$R_{\rm p}$ = 68 Ω	Forms with C_p a low pass filter in the supply line for
$C_{\rm p} = 100 \rm pF$	improving the EM immunity

The same optimization points as for the three-wire application apply.

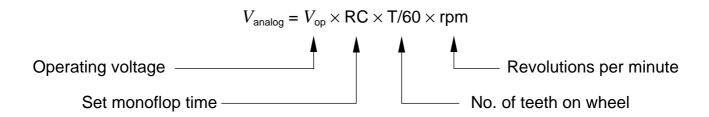
Detecting Speed of Rotation

The output signal of the gear-tooth-sensor is rectangular. Each alteration of the switching status represents a change from tooth to gap or vice versa. The duty cycle for a rectangular tooth-wheel (e.g. modulus 2) and sensing distance of 1 to 2 mm is virtually 1:1.

Depending on the application the speed information will be required in digital form or in analog form as a voltage.

Analog Evaluation

Speed control is the commonest task in classic control engineering. The controlled variable that is taken for an analog controller (P, PI, PID) is a voltage proportional to the speed. The first step in obtaining this speed proportional voltage is that the sensor output signal is converted into a rectangular signal fixed ON-time and a variable OFF-time, dependent on the speed, by an edge-triggered monoflop. In the second step the linear average is formed. This, using a conversion factor, is directly proportional to the speed.



A moving-coil meter is especially suitable for analog display of the speed. This is an ideal averager above a lower cut-off frequency of typically 10 Hz.

If the speed-proportional voltage is processed electrically, the average value can be formed by a lowpass filter.

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Digital Evaluation

If the speed-proportional voltage is to be produced as a digital, numeric reading, or if there is a microcomputer available in the system as a digital controller, the speed can be computed very easily for these purposes.

The gear-wheel sensor is connected to the count input of a microcontroller (e.g. external input of timer 0 on an 8051). The speed is detected by counting the HIGH/LOW transitions of the sensor output in a defined time window $T_{\rm window}$. By careful definition of this time window, the speed can be produced directly as an rpm figure without conversion.

$${\rm Speed}\, [{\rm rpm}] \, = \, \frac{{\rm Counted}\, {\rm pulses}}{T_{\rm window}} \qquad \qquad {\rm with}\, \, T_{\rm window} \, [{\rm s}] \, = \, \frac{60}{{\rm Number}\, {\rm of}\, {\rm teeth}}$$

Example: A gear wheel with 15 teeth requires a time window of 4 s.

If one pulse is counted in the time window, this will correspond to 1 rpm.

This is at the same time the finest resolution that is possible.

Because of the high operating frequency of the microcontroller however, it is bothersome to set long time windows. If you select a shorter time window, the count has to be multiplied by a correction factor in the ratio of the ideal to the real time window. The metering accuracy and resolution that are achieved can nevertheless only amount to this factor at the maximum.

Example: Gear wheel with 15 teeth time \rightarrow window 4 s.

Real time window 40 ms \rightarrow correction factor 100.

If one pulse is counted in the set time window, this will correspond to 100 rpm.

If none is counted, the display will be zero.

It is seen that the lower metering limit is determined by the choice of time window.

Detecting Sense of Rotation

With Logic

Detecting the sense of rotation is a very simple matter with two sensors. These sensors should be arranged on the circumference of the tooth wheel so that their output signals are offset 90 $^{\circ}$ in phase. The switching sequence of the sensors is converted into a static directional signal by an edge-triggered D-flipflop, because one sensor will switch earlier than the other depending on the sense of rotation.

The output signal of the dynamic tooth-wheel sensor is only valid above a minimum speed, this also applying to the direction signal that is obtained. So when a gear wheel is braked and started again in the opposite direction, the output signals and the direction signal about the standstill point are not particularly reliable.

With Software

The switching sequence can also be evaluated by a microcontroller and software. The sensor signals are connected to two interrupt inputs. At the same time it is possible to monitor the lower cut-off frequency by software. The sensor signals are not evaluated if they go beyond the lower cut-off frequency.

The principle of detecting sense of rotation is illustred in **figure 13**.

A proven application circuit for analog sensing of rotational speed and sense is shown in **figure 14**.

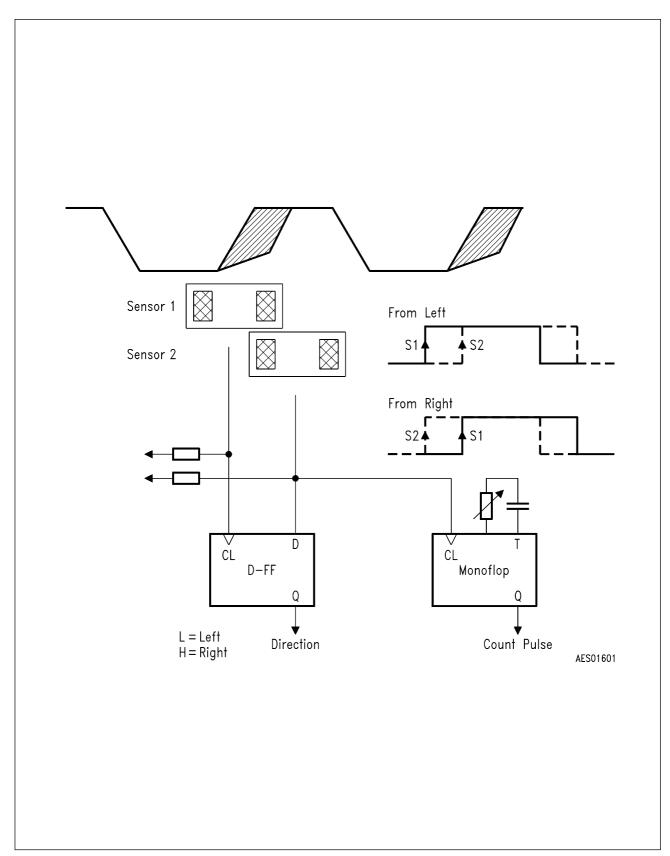


Figure 13
Detecting Sense of Rotation with Two Gear-Wheel Sensors

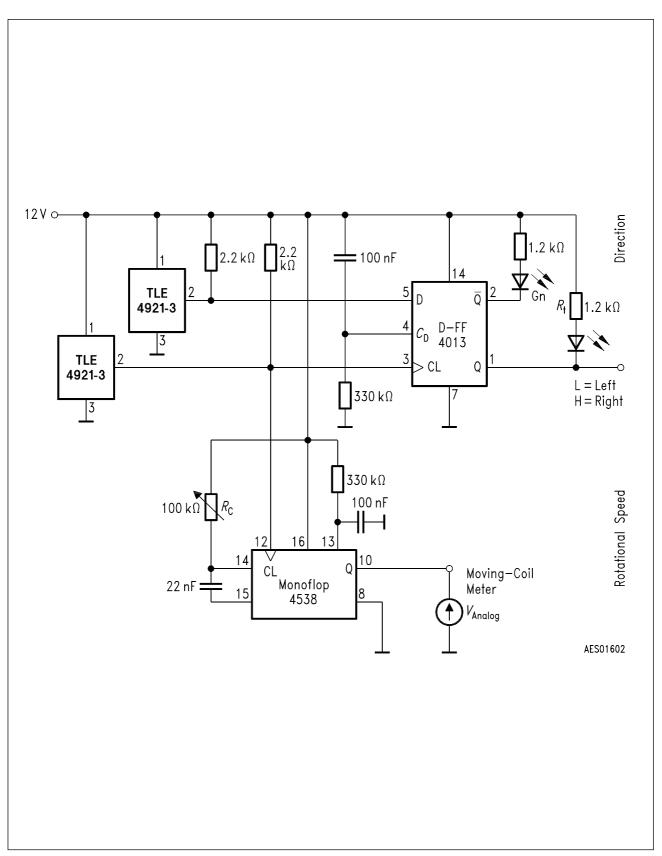


Figure 14
Application Circuit Rotational Speed/Rotational Sense

Signal Behaviour for different Dimensions of Toothed Gear Wheels

In order to give detailed information regarding to the signal behaviour for different gear tooth dimensions, the main points that influence the performance of a sensor/toothed wheel configuration are described below.

The following figures show the internal differential signal coming from two Hall elements, receiving a direct information on how the dimensions influence the performance.

The differential signal increases with the ferromagnetic mass and therefore with the tooth pitch T. If T is increased to more than 8 mm, the gradient becomes flat. Hence the optimum rating is then between 5 and 8 mm (**figure 15**).

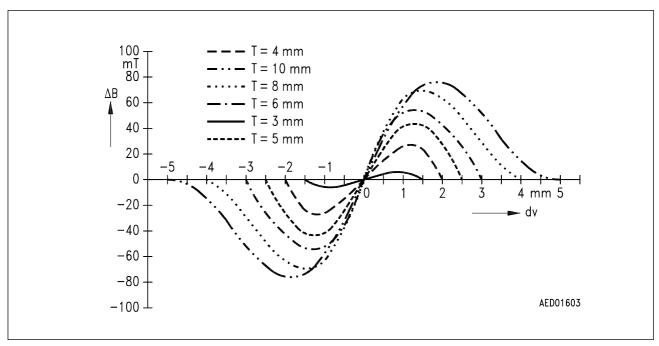


Figure 15
Differential Signal as a Function of Pitch T

According to the definition the position dv = 0 mm is where the tooth of the wheel is centered over the IC. Therefore at this position the differential signal is 0 (both Hall elements are influenced by the same magnetic flux). At the position where one Hall element faces a gap and the second element faces a tooth, the differential field has a maximum (dv = 1.25 mm). If T equals 5 mm then the differential signal is sinusoidal because the distance between the sensors is 2.5 mm = T/2 (see **figure 16**).

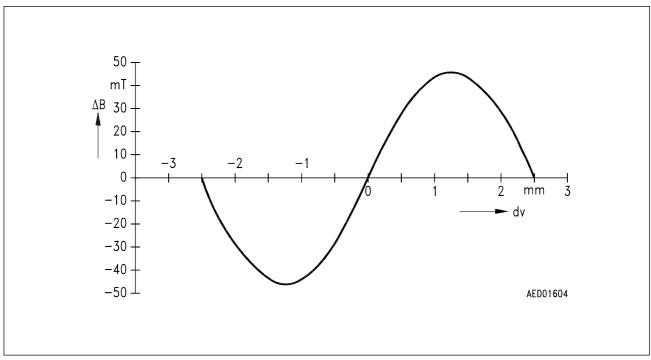


Figure 16
Differential Signal for a Pitch T = 5 mm

If T/2 is smaller than 2.5 mm, the influence of the gaps decreases and the Hall elements already detect the next tooth (**figure 17**).

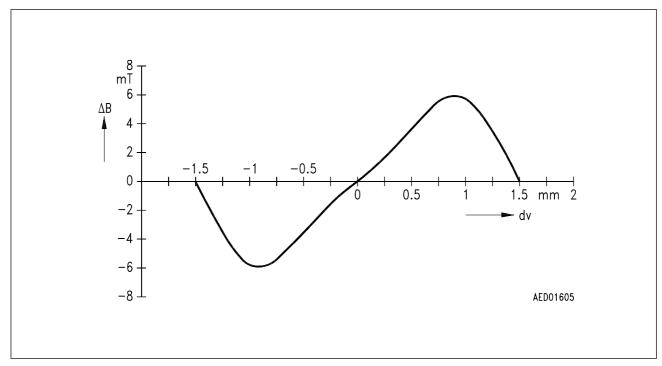


Figure 17
Differential Signal for a Pitch T = 3 mm

If T/2 is larger than 2.5 mm, the influence of the gaps increases and the Hall elements do not detect the next tooth (**figure 18**).

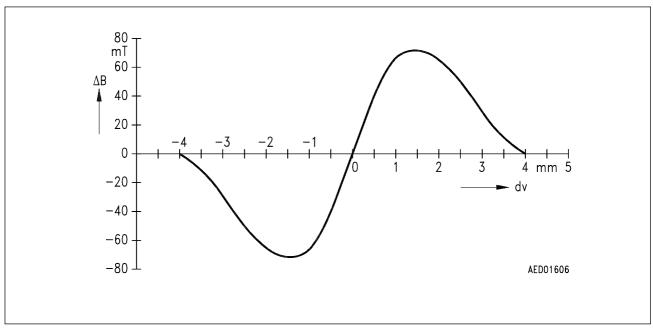


Figure 18
Differential Signal for a Pitch T = 8 mm

Figure 19 shows the influence of slanted teeth.

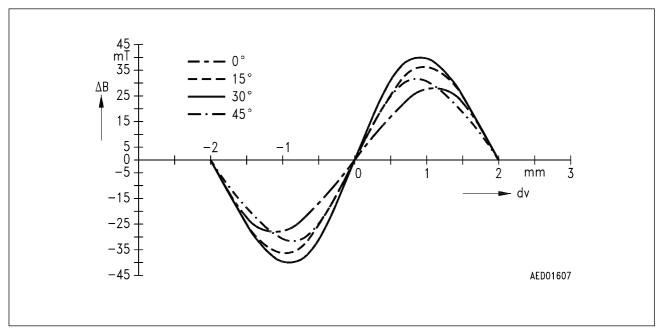


Figure 19
Differential Signal for Teeth with Different Slant

The differential signal for different tooth height Zh for T = 5 mm is shown in **figure 20**. Zh equal to 5 mm already produces a large amplitude. A further increasing of Zh only leads to small improvements.

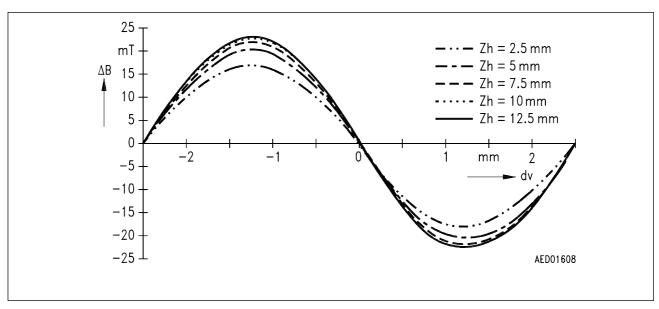


Figure 20
Differential Signal as a Function of Tooth Height, T = 5 mm

Of special interest, together with the influence of tooth geometry, is the signal behaviour of the sensor for varying airgaps dA. in **figure 21** the differential signal of a toothed wheel with T = 4 mm and dv = 1 mm is shown as a function of the effective airgap.

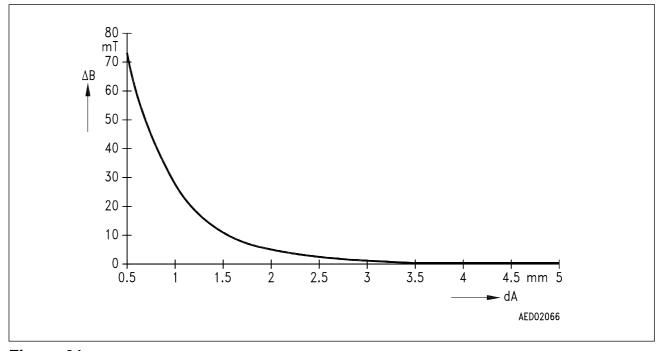


Figure 21 Differential Signal as a Function of Airgap dA for T = 4 mm and dv = 1 mm

A summary of the discussed points is shown in figure 22:

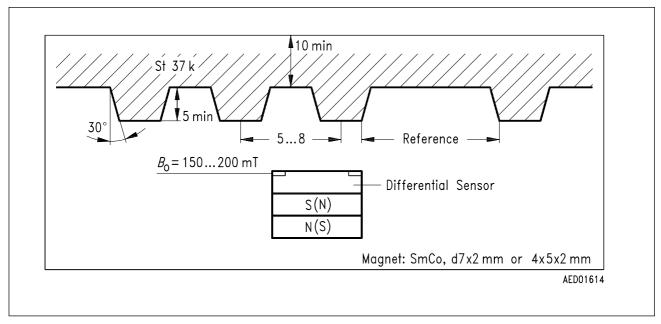


Figure 22
Optimum Application Configuration for the Differential Sensors,
Dimensions in mm